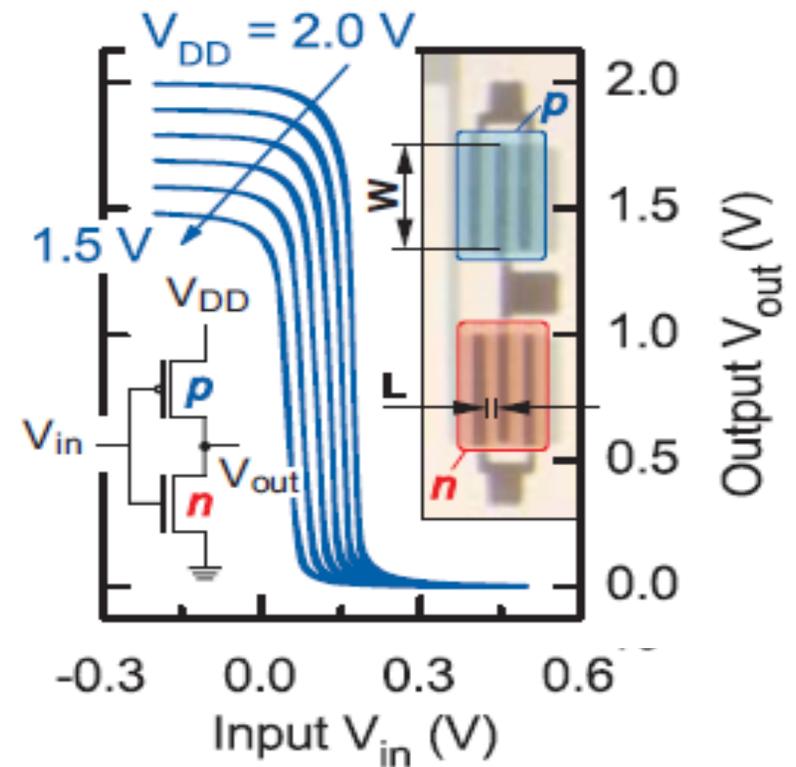


Enhanced OTFT performance by optimized trap control

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Laboratory for Solid State Physics
ETH Zurich, Switzerland

Thanks to

Wolfgang Kalb	Arno Stassen
Tobias Morf	Kurt Pernstich
Simon Haas	David Gundlach
Kurt Mattenberger	
Thomas Mathis	
Fabian Meier	
Matthias Walser	



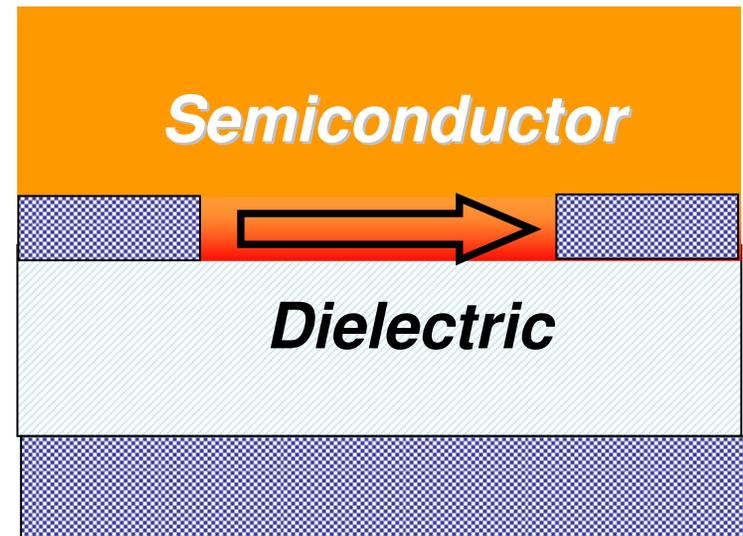
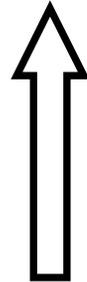
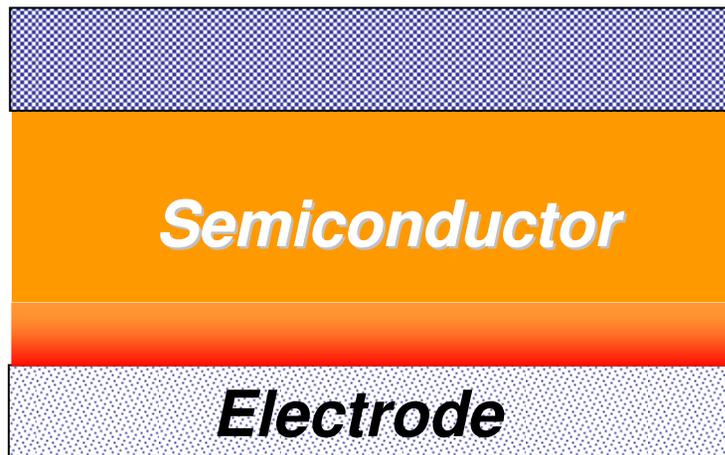
ETH

Eidgenössische Technische Hochschule Zürich
Swiss Federal Institute of Technology Zurich

PHYSICS
OF
NEW MATERIALS

Organic electronics: bulk and interfaces issues

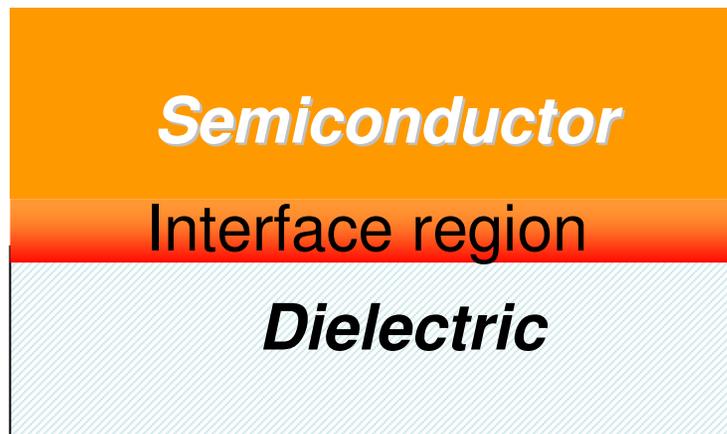
*The FET is an “interface” - device :
charge is concentrated at semiconductor – dielectric interface*



*Charge traps:
Barriers against charge injection*

*Charge traps:
Reduction of mobile charge density*

- Identify trap DOS
- Quantify trap DOS (bulk, thin film, interface)
- Eliminate traps



Measure the trap DOS

bulk

TFT

SC FET

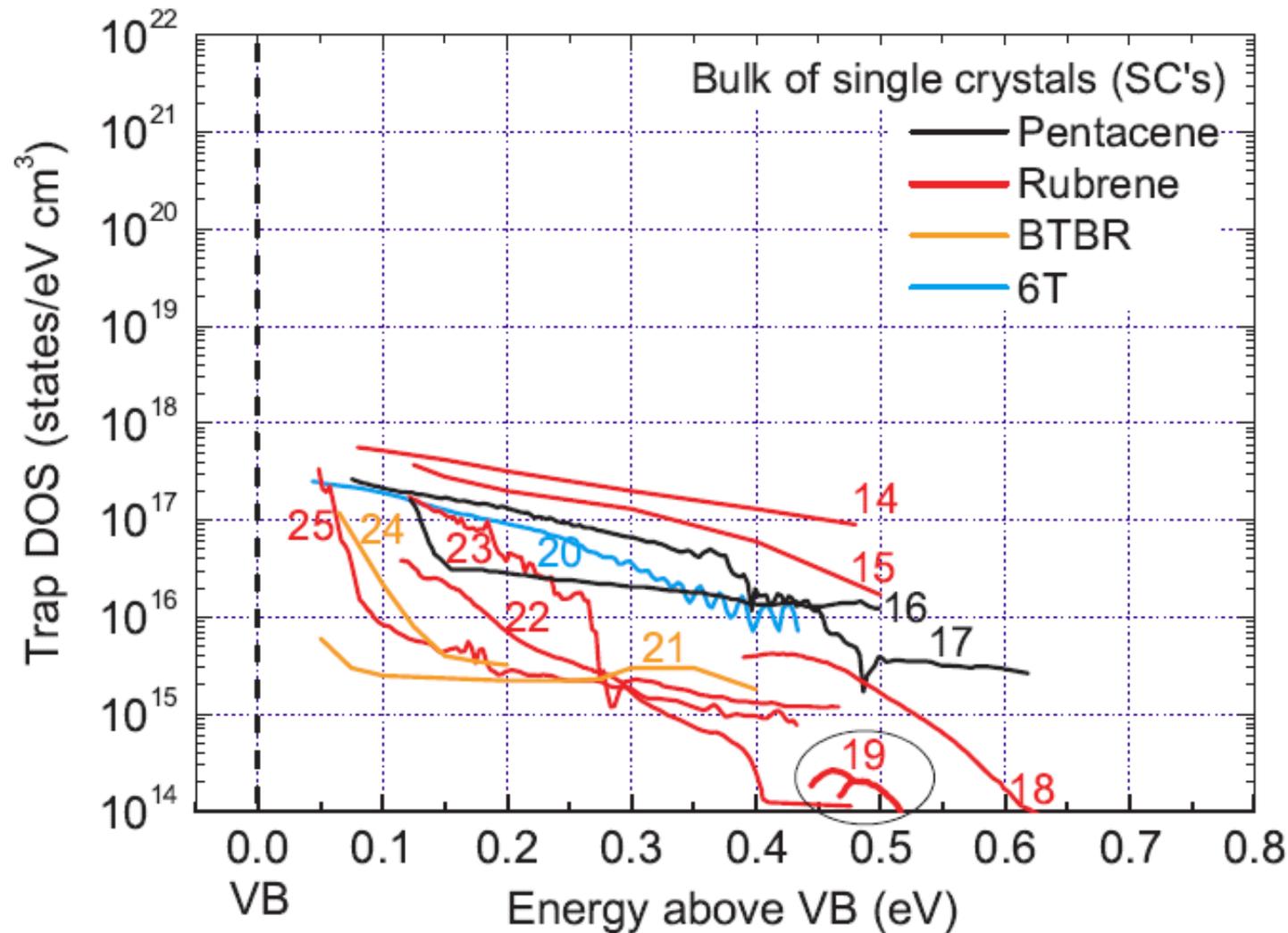
Trap reduction by RT annealing
O₂ induced traps in Pc thin films

choice of dielectric material
high-quality complementary TFTs
low-voltage TFTs

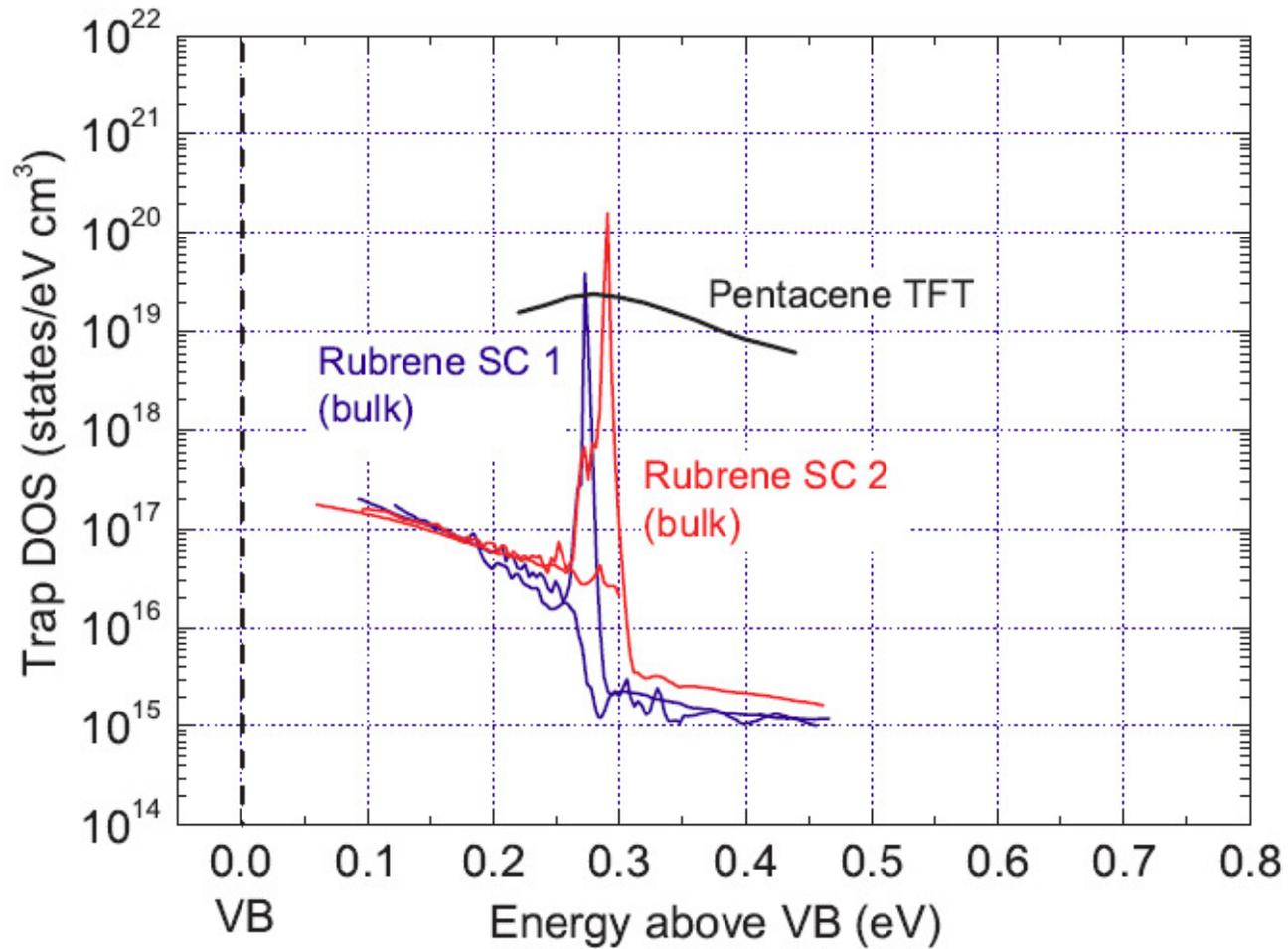
Comparison of trap DOS in organic and in inorganic semiconductors :

Interface traps compared to bulk traps?

Bulk trap DOS in organic molecular crystals

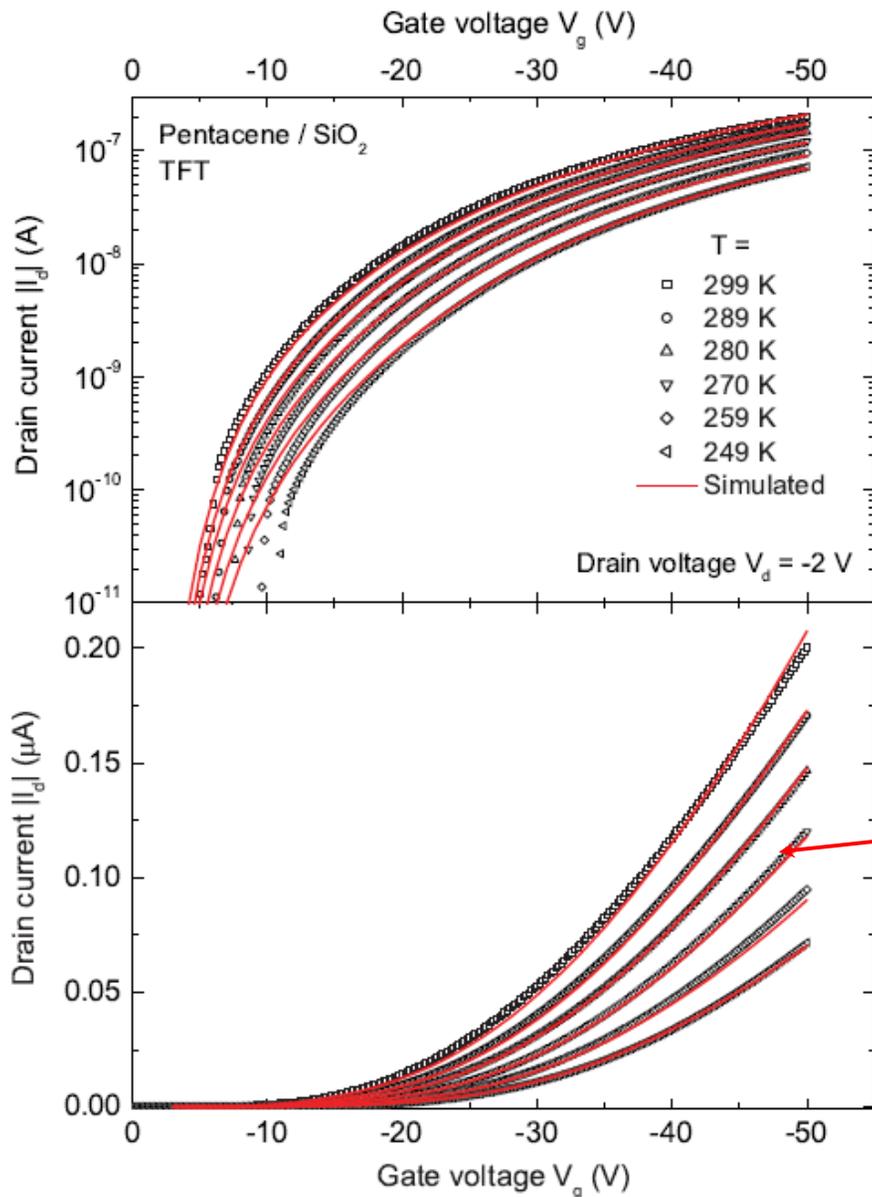


Oxygen induced trap levels



C. Krellner et al. Phys. Rev. B 2007

Quantitative evaluation of trap DOS in TFTs



Starting data set:

Transfer characteristics of a Pentacene TFT on SiO₂

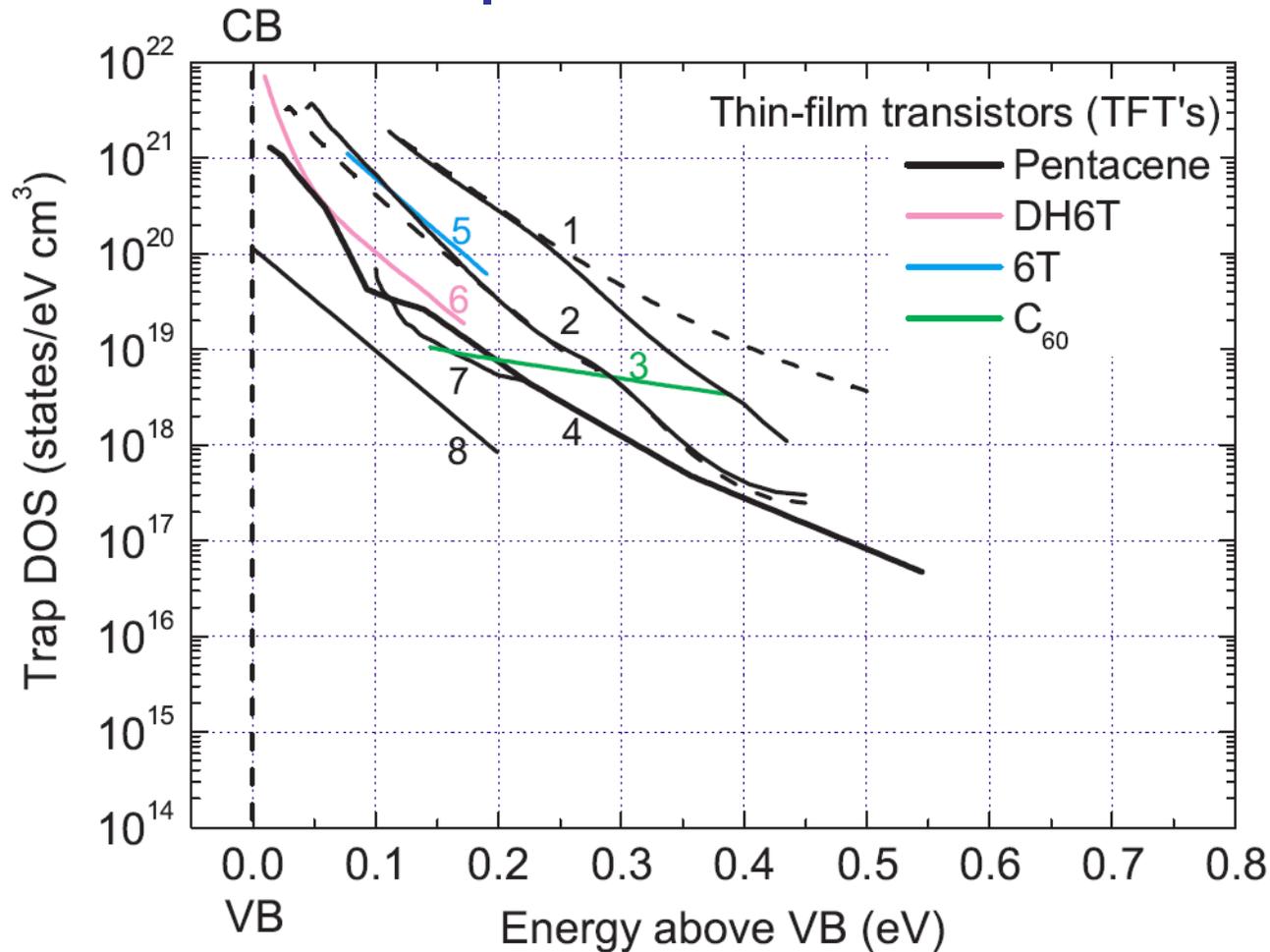
Relatively high trap density :
subthreshold swing
reduced FET mobility : ~ 0.2 cm²/Vs

Simulation result (DOS, mobility)
(code by Oberhoff et al., ETH ZH)

W. L. Kalb and BB,
Phys. Rev. B 81, 035327 (2010)

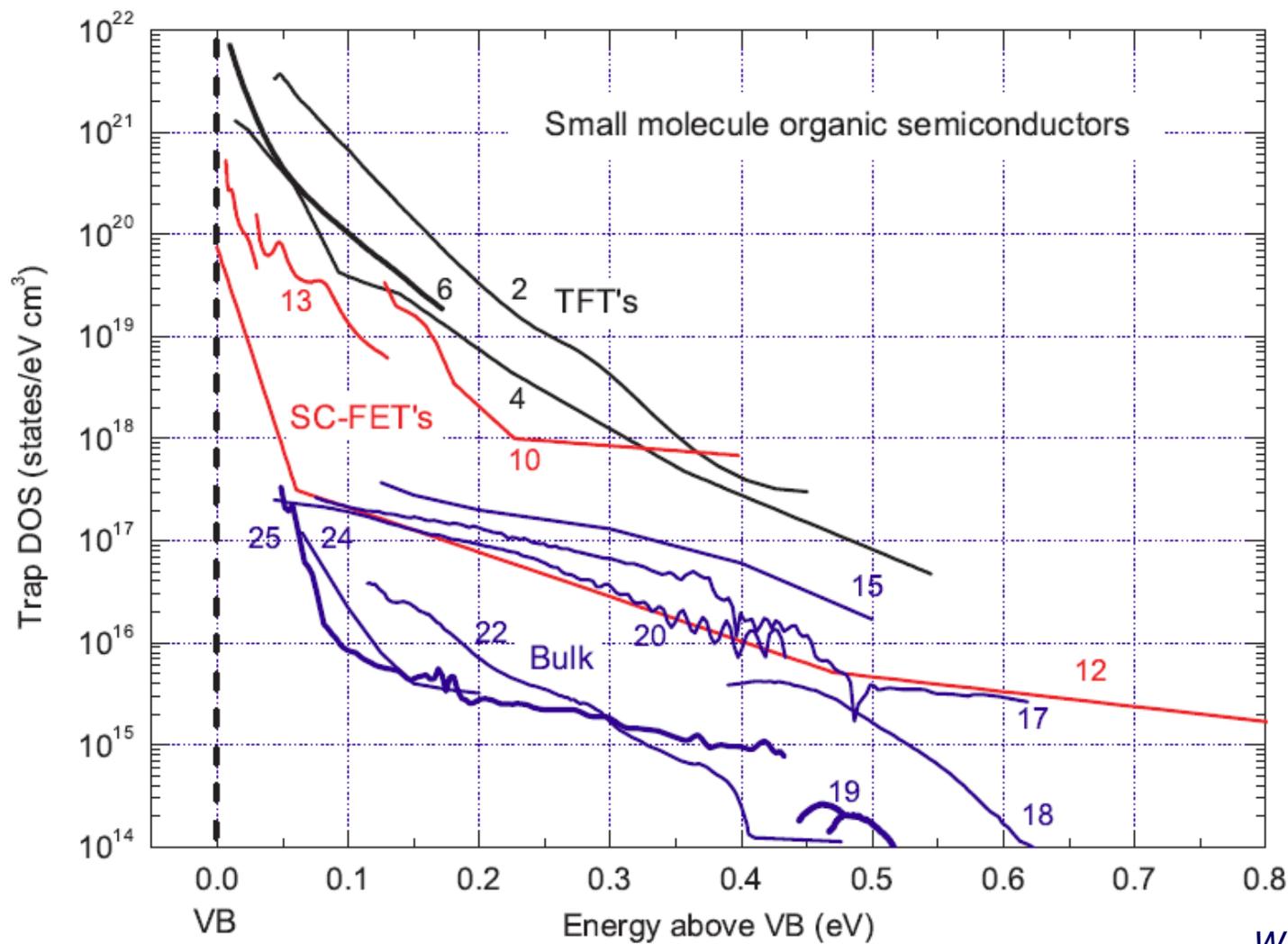
D. Oberhoff, K. P. Pernstich, D. J. Gundlach, and B. B.,
IEEE Trans. Electron Devices 54, 17 (2007)

Trap DOS in TFT



- 1 Pc W. L. Kalb, et al. *Phys. Rev. B* 78, 035334 (2008).
- 2 Pc W. L. Kalb, et al., *Appl. Phys. Lett.* 90, 092104 (2007).
- 3 C₆₀ N. Kawasaki, et al. *Appl. Phys. Lett.* 91, 243515 (2007).
- 4 Pc F. De Angelis, et al., *Appl. Phys. Lett.* 88, 193508 (2006)., *Appl. Phys. Lett.* 86, 203505 (2005).
- 5 6T G. Horowitz et al., *J. Phys. III France* 5, 355 (1995).
- 6 DH6T G. Horowitz, et al., *J. Phys. III France* 5, 355 (1995).
- 7 Pc C. Vanoni, et al., *Appl. Phys. Lett.* 94, 253306 (2009).
- 8 Pc A. R. Volkel, et al., *Phys. Rev. B* 66, 195336 (2002). D. Knipp, et al., *Proc. SPIE* 4466, 8 (2001).

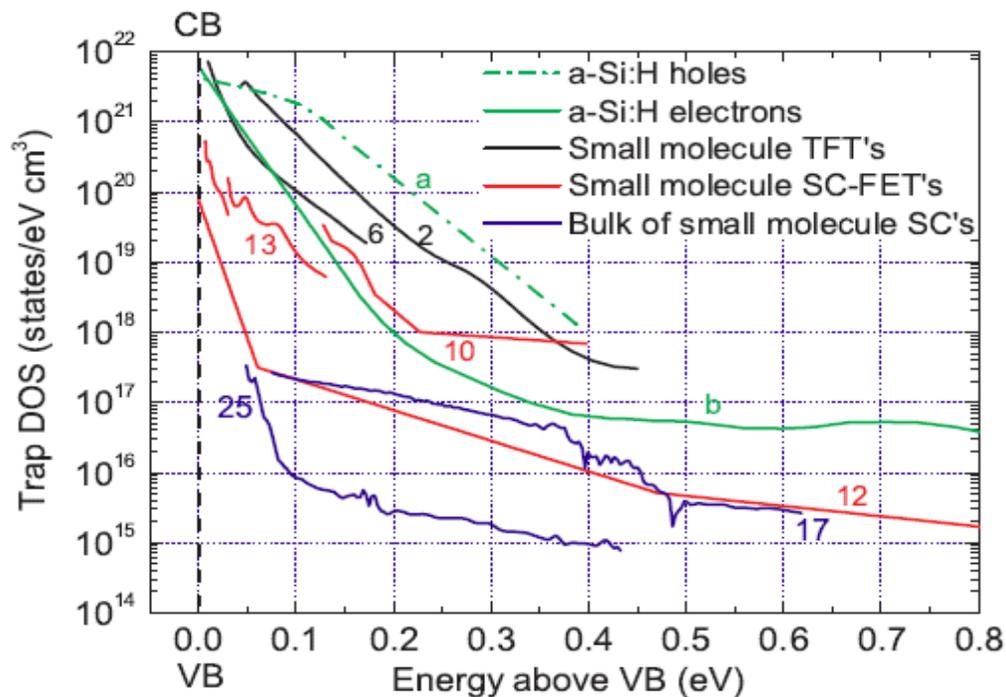
Comparison : trap DOS in small-molecule organic semiconductors



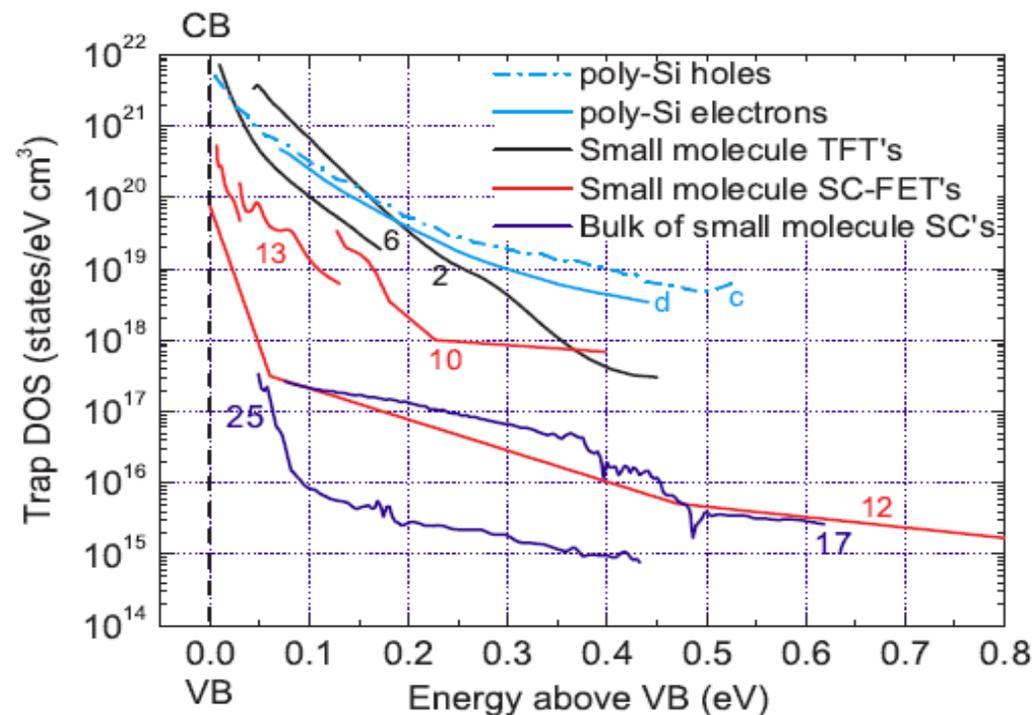
W. L. Kalb et al.,
Phys. Rev. B (2010)
arXiv:1002.1611v1

Electronic trap DOS : OMC compared to a-Si:H and poly-Si

a-Si:H

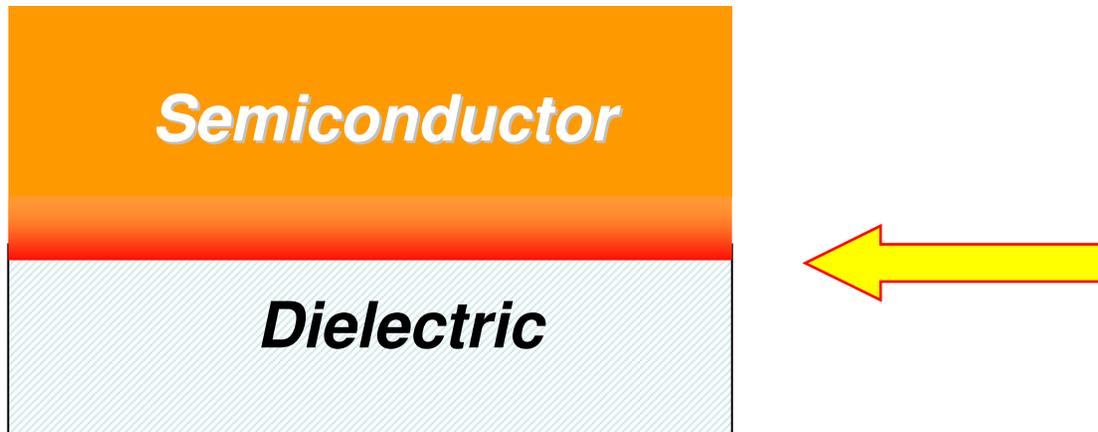


Poly Si



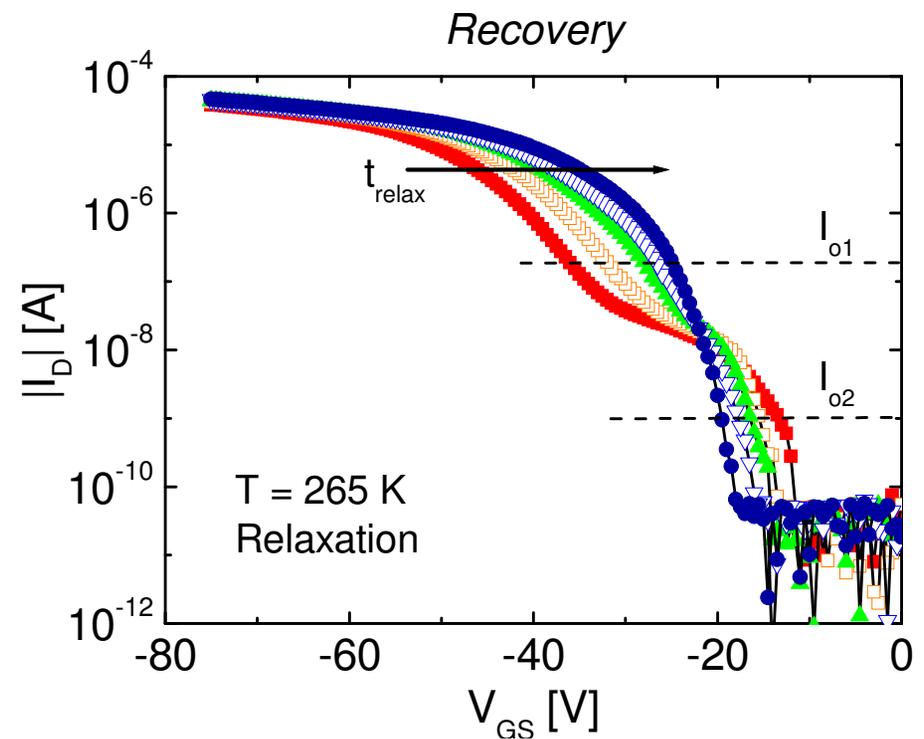
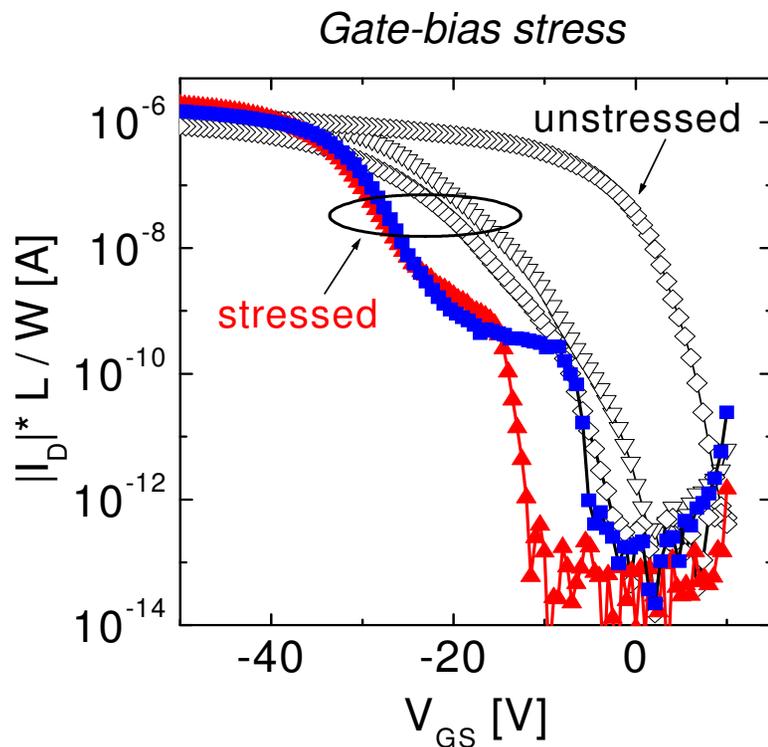
W. L. Kalb et al.,
Phys. Rev. B (2010)
arXiv:1002.1611v1

Traps associated with the dielectric – semiconductor *interface*



Example of interface trap states:

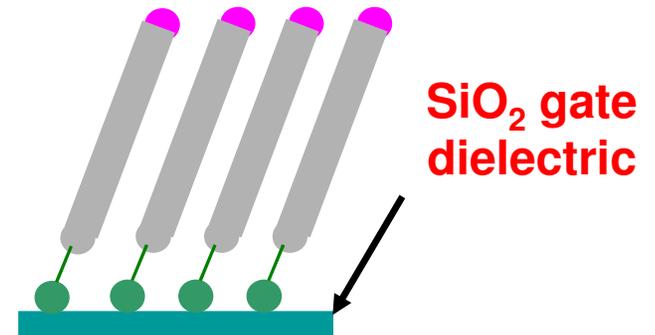
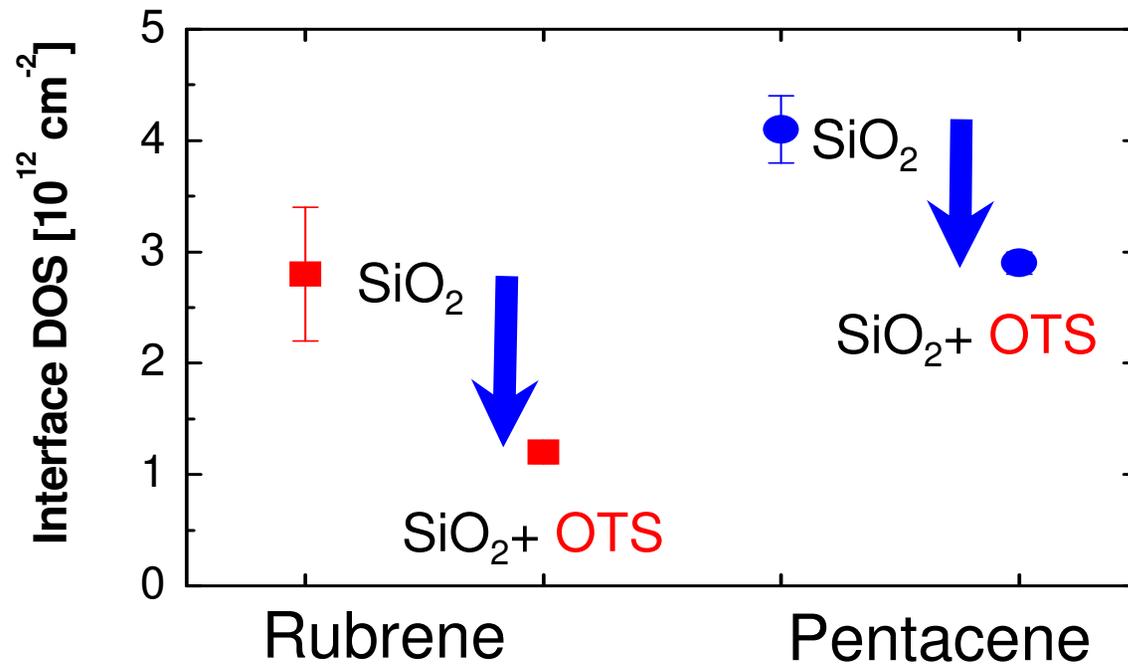
water-related discrete trap level in Pentacene SC-FET



C. Goldmann et al., *Appl. Phys. Lett.* 88, 063501 (2006)
K. P. Pernstich et al., *Appl. Phys. Lett.* 89, 213509 (2006)

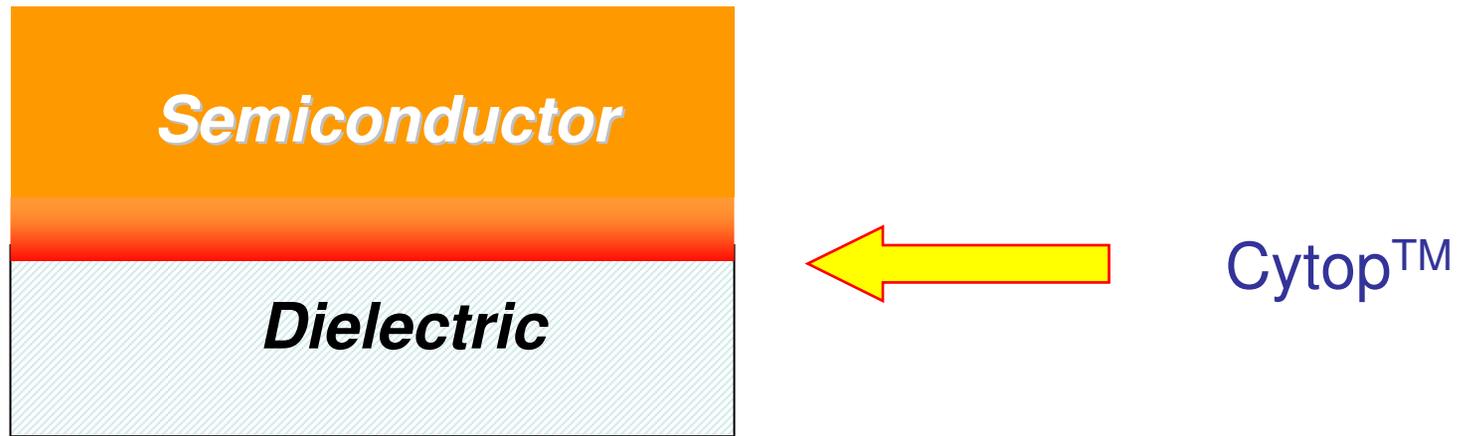
H. L. Gomes et al., *Appl. Phys. Lett.* 88, 082101 (2006)
M. L. Chabinyk et al., *Appl. Phys. Lett.* 88, 113514 (2006)

Interface traps in Rubrene & Pentacene s.c. FETs hydrophilic – hydrophobic dielectric surface



$$D = n_{average,2D} \cdot 1.5 / (1.5 \text{ nm} \cdot \Delta E_F)$$

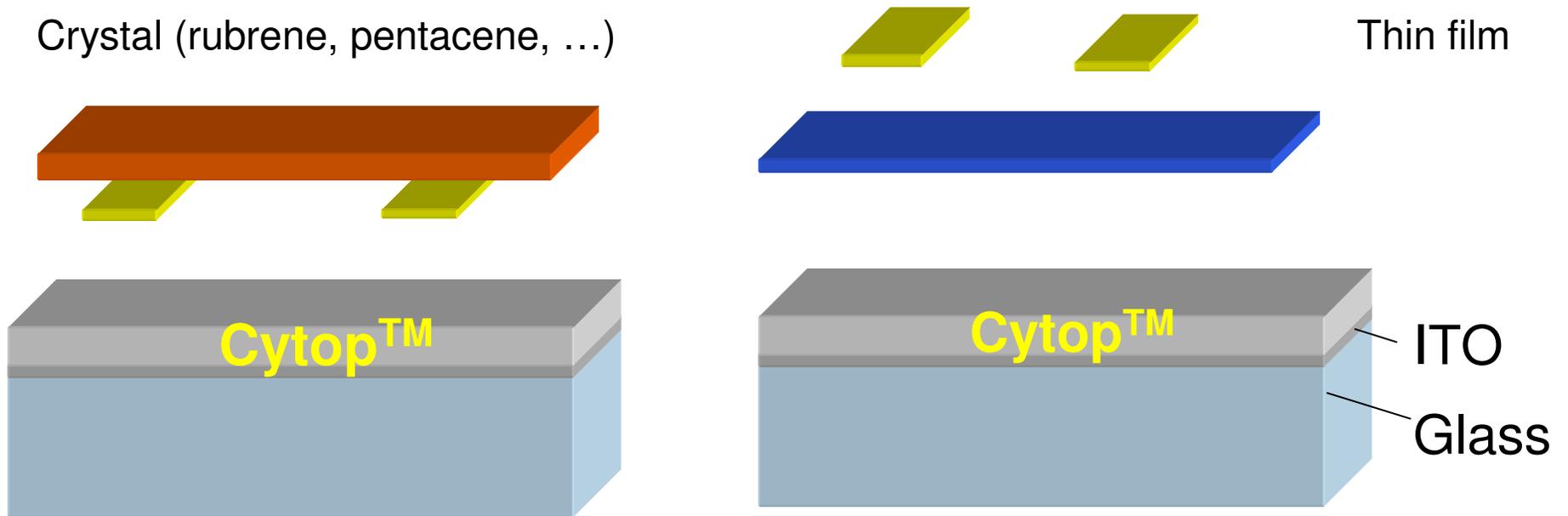
Interface trap DOS reduction : fluorinated polymer Cytop™



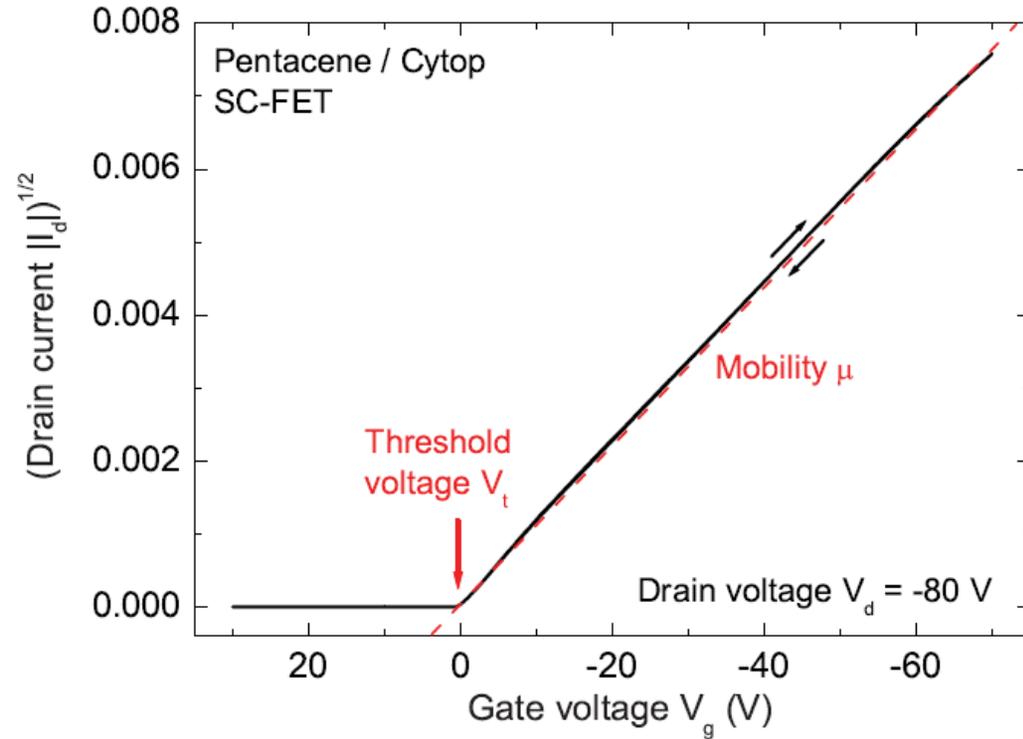
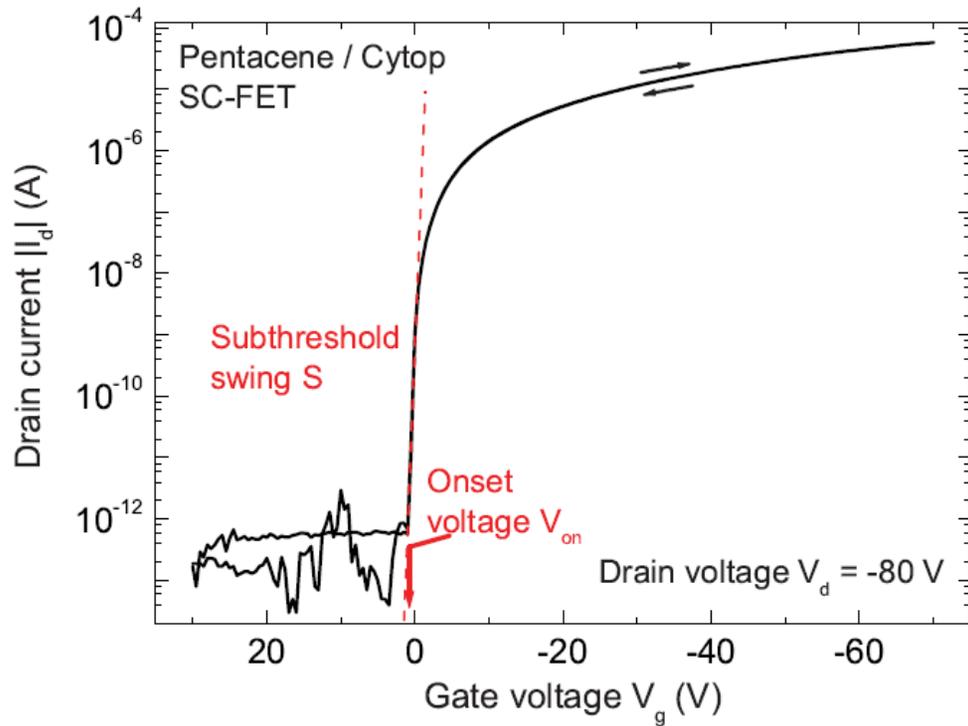
W. L. Kalb, T. Mathis, S. Haas, A. F. Stassen, B. B.,
Appl. Phys. Lett. 90, 092104 (2007)

Device fabrication

- Common bottom gate structure
- ITO gate / Cytop™ films by spin-coating
- Thickness : 430 to 700 nm ($C_i = 4.4-2.7 \text{ nF/cm}^2$)



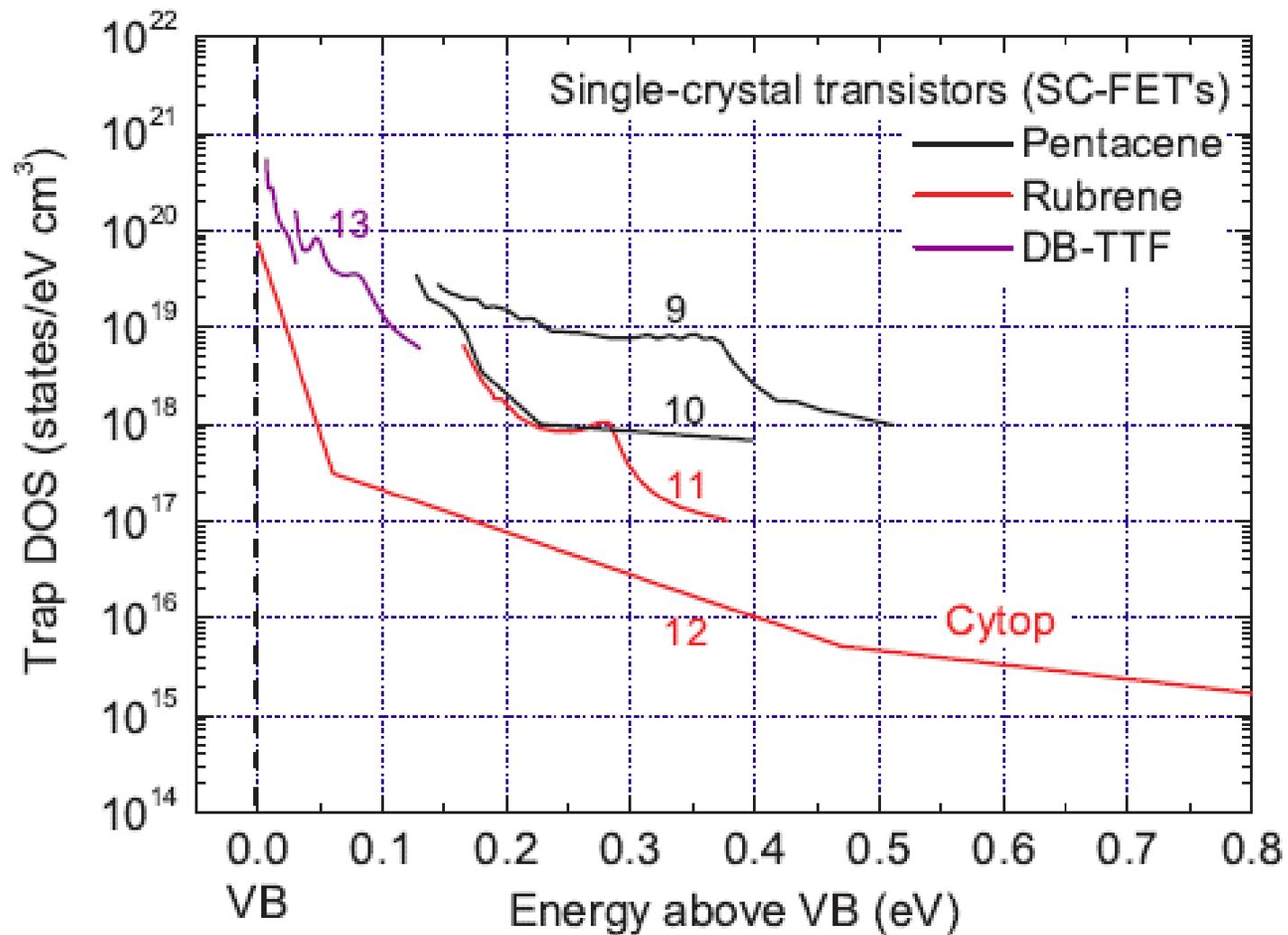
Single-crystal / Cytop FET



$$S = \frac{kT \ln 10}{e} \left[1 + \frac{e}{C_i} (\sqrt{\epsilon_s N_{bulk}} + e N_{int}) \right]$$

$$S = \frac{kT \ln 10}{e} \left[1 + \frac{e^2}{C_i} N_{\square} \right]$$

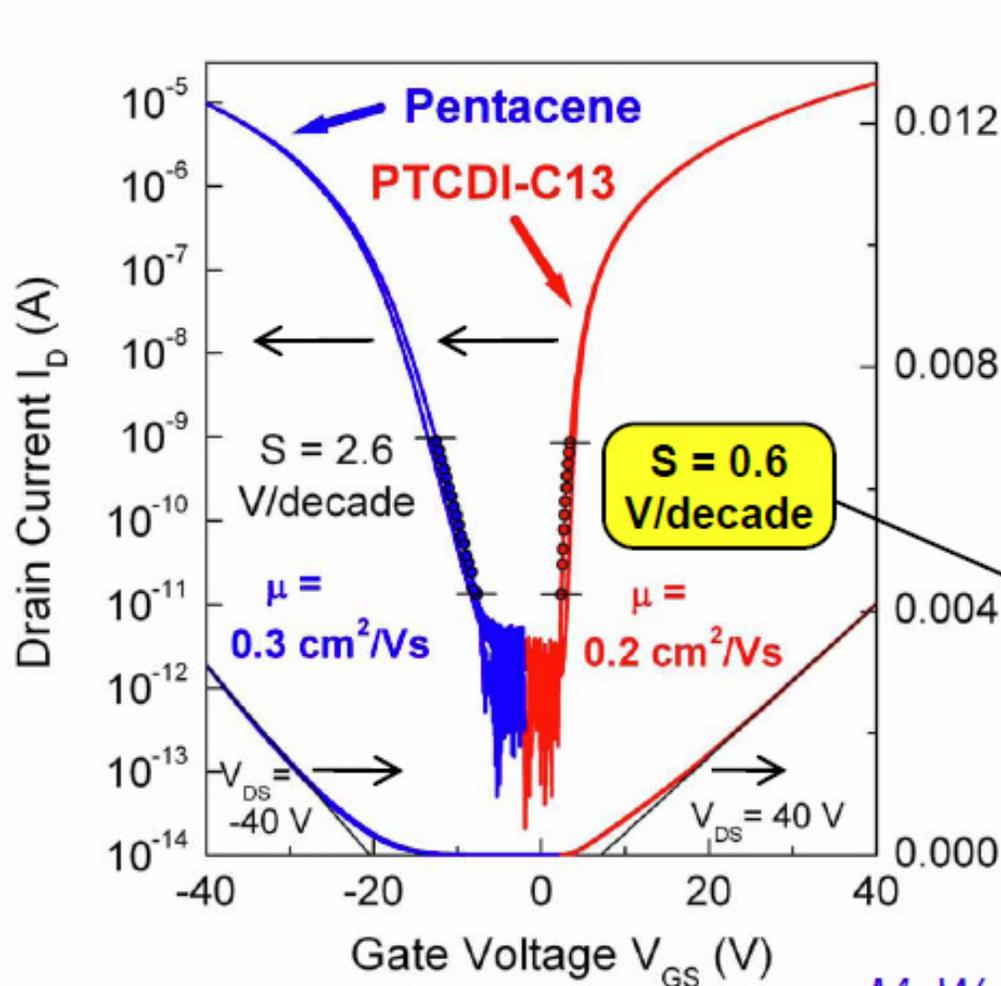
Single crystal FET trap DOS



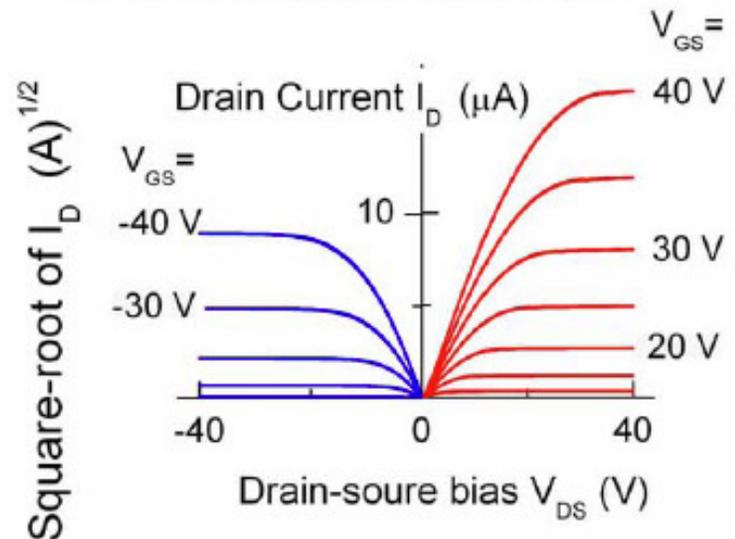
W. L. Kalb et al.,
Phys. Rev. B (2010)
arXiv:1002.1611v1

SiO₂ + 8nm Cytop

Transfer characteristics



Output characteristics



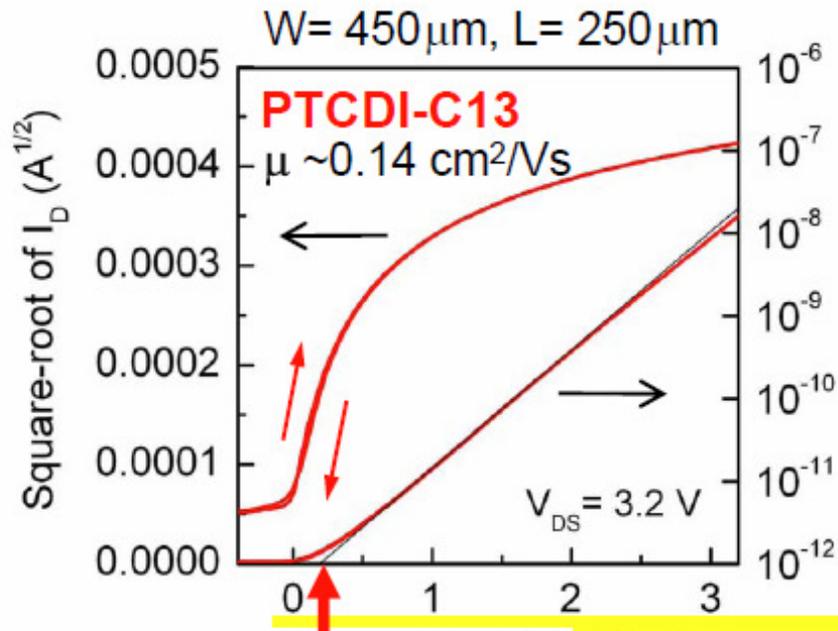
Steep current onset
Nearly no hysteresis
 \Rightarrow **Low interface trap density**

M. Walser et al., APL 95, 233301 (2009)

Increasing the capacitance

18 nm Cytop™ only

~ 100 nF/cm²

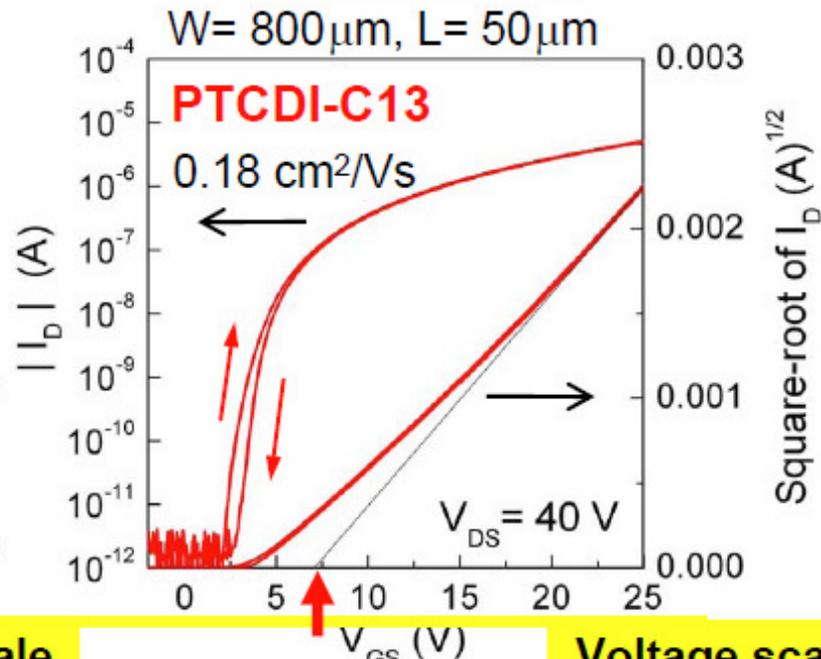


$V_T = 0.2 \text{ V}$

Voltage scale
1 - 10 V

SiO₂ + 8 nm Cytop™

~ 12 nF/cm²



$V_T = 7 \text{ V}$

Voltage scale
10 - 100 V

M. Walser et al., *APL* **95**,
233301 (2009)

M. Walser et al., *APL* **94**,
053303 (2009)

Low-voltage transistor

Steep onset ~ 0.2 V/decade

No hysteresis

Electrically stable

Low and stable

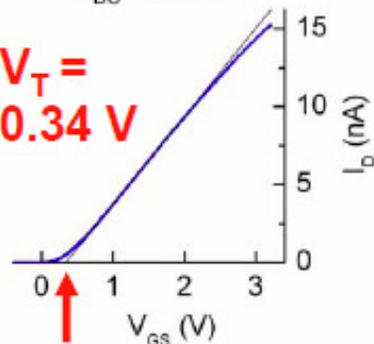
Threshold voltage

(14mV shift after 3h at 2V)

Linear Regime

$V_{DS} = 0.2$ V

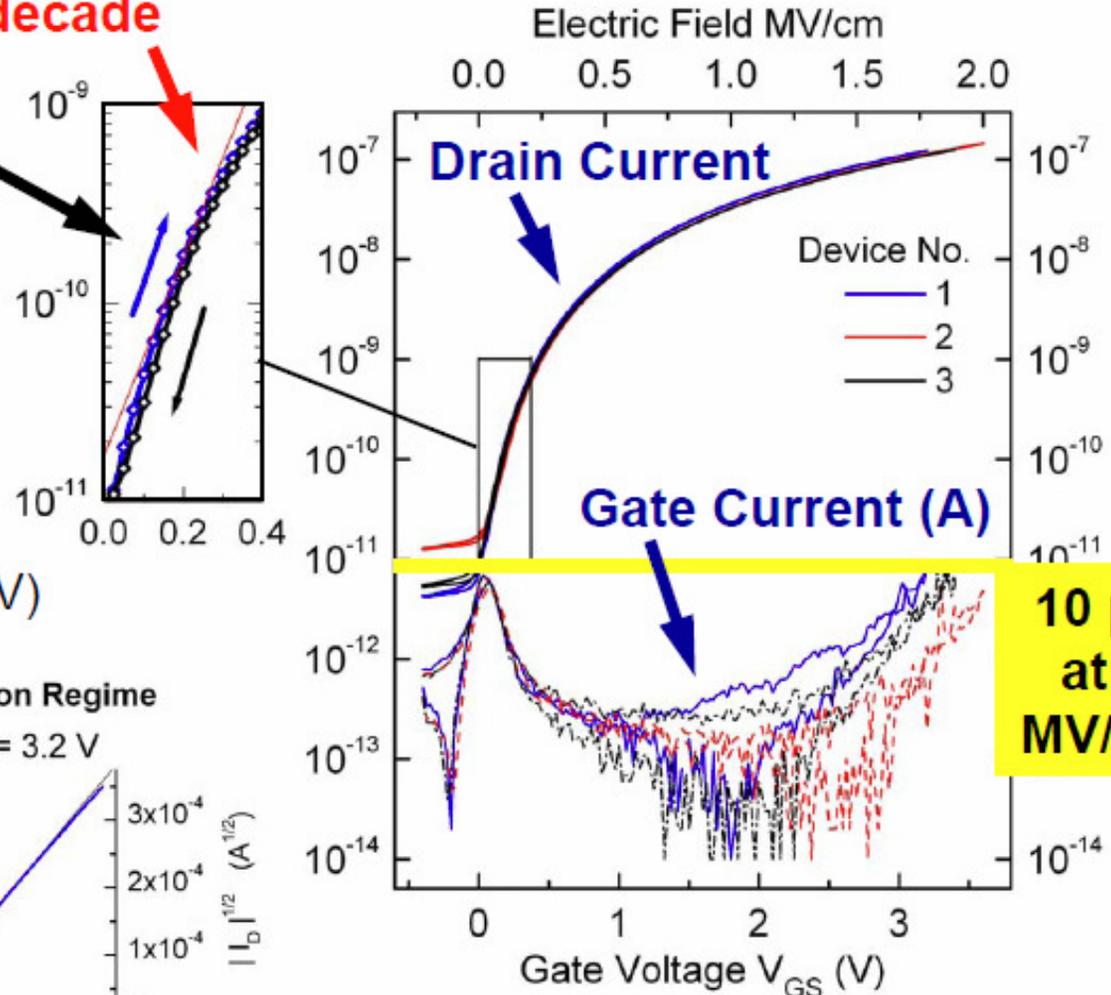
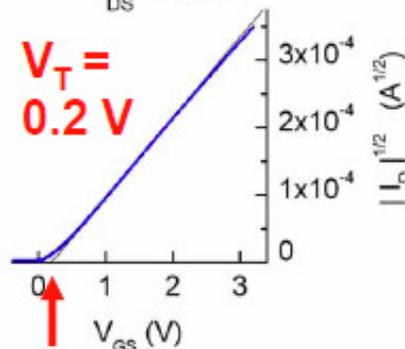
$V_T = 0.34$ V



Saturation Regime

$V_{DS} = 3.2$ V

$V_T = 0.2$ V



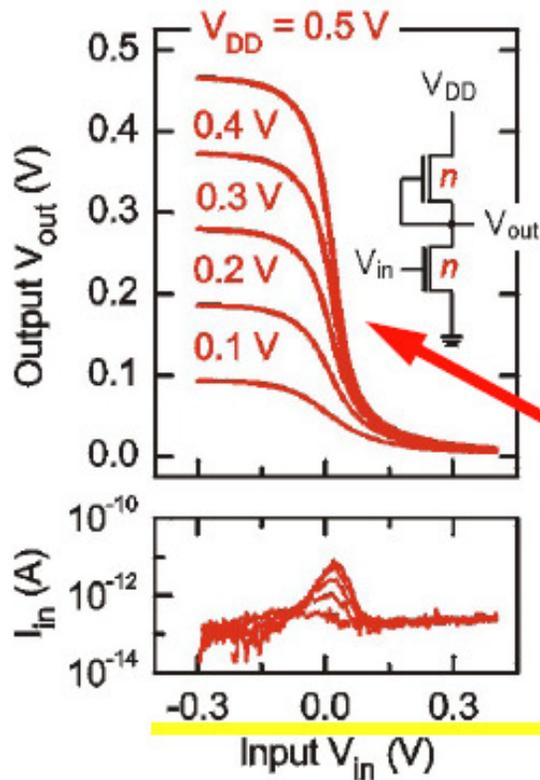
M. Walser et al., APL 95, 233301 (2009)

10 pA
at 2
MV/cm

Low voltage inverters

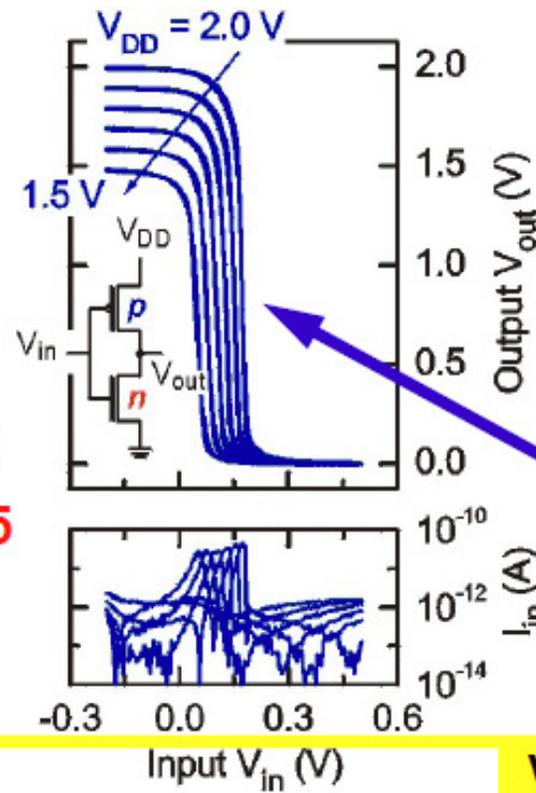
- Thin gate dielectric
⇒ Low operating voltage
- P-type and n-type
⇒ Complementary inverter

N-type inverter



**Maximal
Gain - 4.5**

Complementary inverter



**Maximal
Gain - 80**

**Voltage scale
0.1 - 1 V**

M. Walser et al., APL 95, 233301 (2009)

Summary

*Trap DOS in organic TFTs :
very similar to DOS in a-Si:H*

*Organic semiconductor :
Stable in appropriate combination*

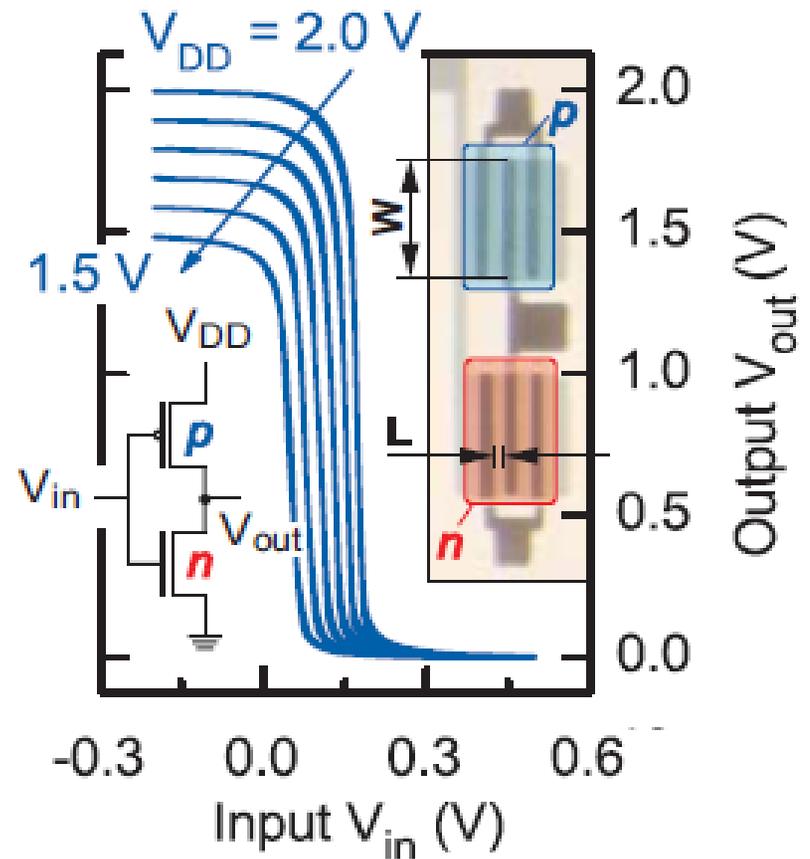
Impressive progress in recent years

-semiconductors:

- sufficiently high mobility*
- n - and p- conducting*
- stable*

-gate dielectrics

- low interface trap density*
- ultrathin*



*Integrated p- & n-type FETs
with fluorinated Cytop dielectric*

Recent pertinent papers

Calculating the trap density of states in organic field-effect transistors from experiment: A comparison of different methods

Wolfgang L. Kalb and Bertram Batlogg
PHYSICAL REVIEW (2010)

The trap DOS in small molecule organic semiconductors: A quantitative comparison of thin-film transistors with single crystals

Wolfgang L. Kalb, Simon Haas, Cornelius Krellner, Thomas Mathis, and Bertram Batlogg
PHYSICAL REVIEW (2010)

Low-voltage organic transistors and inverters with ultrathin fluoropolymer gate dielectric

M. P. Walser, W. L. Kalb, T. Mathis, and B. Batlogg
APPLIED PHYSICS LETTERS 95, 233301 (2009)

Also:

APPLIED PHYSICS LETTERS 94, 053303 (2009)